P26669.P08 / 0 - / (- 0 5	10-14	-2005	
FORM PTO-1595			U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE
To the Honoradia Director of Patent 1. Name of Conveying party(les): Reiko KAWAMURA Yuya EGAWA OCT 1 1 2005	10310	Name and add	jinal documents or copy thereof. ress of receiving party(ies) Chemicals Co., Ltd.
		Internal Address:	
Additional name(s) of conveying party(ies) attached?Yes 3. Nature of conveyance: X AssignmentMerger	X No	Street Address:	12-6, Tsukiji 1-chome, Chuo-ku, Tokyo 104-0045 Japan
Security Agreement Change of Name Other Execution Date: September 13, 2005			State: ZIP:es(s) and address(es) attached? X Yes No
 4. Application number(s) or patent number(s): If this document is being filed together with a new application A. Patent Application No.(s) 10/524,420 	В	. Patent No.(s)	
Name and address of party to whom correspondence concerd document should be mailed:	erning 6		No f applications and patents involved: _1
Name: Bruce H. Bernstein Internal Address: P26669		Total Fee (37C X Enclosed Authorized to	FR 3.41) \$40.00 be charged to deposit account
Street Address: GREENBLUM & BERNSTEIN, P.L.C. 1950 Roland Clarke Place City: Reston State: VA	ZIP: <u>20191</u>	(Attach dup	19-0089 Slicate copy of this page if paying by deposit account)
9. Statement and signature. To the best of my knowledge and belief, the foregoing infor Bruce H. Bernstein, Reg. No. 29,027 Name of Person Signing Total number of page	es including cover s	correct and any a Signature heet, attachment	s and document: 5
0/13/2005 EC00PER 00000250 10524420 Director of U.	uments to be record of the United States S. Patent and Trade ustomer Service Wir	Patent and Trademark Office	cover sheet information to: lemark Office, Mail Stop Assignments Recordation Services

Randolph Building 401 Dulany Street Alexandria, VA 22314

LISTING OF ADDITIONAL RECEIVING PARTIES

Name : LEBER Co., Ltd.

Street address : YSK Bldg., 7F, 1-3-11, Shiba-Daimon, Minato-ku,

Tokyo 105-0012, Japan

PATENT REEL: 017069 FRAME: 0151

貴和整理首号: WO302/US 当所整理首号: FA4520M/US

P26669.AS3.doc,doc Page 1

ASSIGNMENT

WHEREAS, Reiko KAWAMURA, a citizen of Japan, whose post office address is c/o PHARMACEUTICAL RESEARCH LABORATORIES, NIKKEN CHEMICALS CO., LTD., 346, Kitabukuro-cho 1-chome, Omiya-ku, Saitama-shi, Saitama 330-0835 Japan, and Yuya EGAWA, a citizen of Japan, whose post office address is c/o PHARMACEUTICAL RESEARCH LABORATORIES, NIKKEN CHEMICALS CO., LTD., 346, Kitabukuro-cho 1-chome, Omiya-ku, Saitama-shi, Saitama 330-0835 Japan hereinafter referred to as the ASSIGNORS, have invented a certain improvement relating to

Soft Capsule Preparation

for which an application for Letters Patent in the United States entered the National Stage in the United States Patent and Trademark Office on February 14, 2005 and was awarded Application No. 10/524,420, and which application is a National Stage of International Application No. PCT/JP03/10440, filed August 19, 2003.

AND WHEREAS, **Nikken Chemicals Co., Ltd.**, a corporation of Japan, whose post office address is 12-6, Tsukiji 1-chome, Chuo-ku, Tokyo 104-0045 JAPAN, and **LEBER Co., Ltd.**, a corporation organized and existing under the laws of Japan, whose post office address is YSK Bldg., 7F, 1-3-11, Shiba-Daimon, Minato-ku, Tokyo 105-0012, JAPAN, are desirous of becoming joint owners, and are hereinafter known as the ASSIGNEES, are desirous of jointly acquiring the entire right, title and interest for the United States in and to said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues, and prolongations thereof.

NOW, THIS WITNESSETH that for and in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt whereof is hereby acknowledged, said ASSIGNORS hereby assign, sell and transfer to said ASSIGNEES, their assigns and legal representatives, the entire and exclusive right, title and interest in and to said Letters Patent, for the United States, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted therefor, and all rights to sue for past and future infringement thereunder, said ASSIGNEES and their assigns and legal representatives to have, hold, exercise and enjoy the said Letters Patent, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges, and advantages in any ways arising from or pertaining thereto, for and during the term or terms of any and all such Letters Patent when granted, including any and all renewals, reissues, and prolongations thereof, for the use and benefit of said ASSIGNEES and their assigns and legal representatives in as ample and beneficial a manner to all intents and purposes as the said ASSIGNORS might or could have held and enjoyed the same, if this assignment had not been made.

> PATENT REEL: 017069 FRAME: 0152

AND said ASSIGNORS hereby agree to execute all papers necessary to file applications in the United States for said Letters Patent and to assign the same to said ASSIGNEES, or any assignee acquiring title to said Letters Patent, and to execute any other papers that may be needed in connection with securing further Letters Patent thereon.

AND said ASSIGNORS authorize and request the Commissioner of Patents to issue Letters Patent, and any and all divisions and continuations thereof, to said ASSIGNEES, their assigns and legal representatives, in accordance herewith.

IN TESTIMONY WHEREOF, this assignment is executed by said ASSIGNORS on the respective dates indicated below.

First Witness:

H	ituo	Iwamoto
(Name)	Million	TLIAMOTO

iame) Mituo IWAMOTO

(Date) September 13, 2005

> Reiko Kawamura Reiko KAWAMURA

September 13, 2005

Second Witness:

(Date) September 13, 2005

REEL: 017069 FRAME: 0153

September 13, 2005

First Witness:

(Name) Mituo IWAMOTO

(Date) September 13, 2005

Second Witness:

RECORDED: 10/11/2005

Masashi Mori

, , , , , abdbiii iidid

(Date) September 13, 2005

PATENT REEL: 017069 FRAME: 0154